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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of  
Coyle et al.

Docket Number: TI-31794

Serial No.: 09/992,387

Art Unit: 2822

Filed: 11/16/2001

Examiner: M. Lewis

For: FLIP-CHIP ON FILM ASSEMBLY FOR BALL GRID ARRAY PACKAGE

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NAME OF INVENTOR(S): <b>COYLE ET AL.</b>	
RECEIPT DATE & SERIAL NO.: Serial No.: <b>09/992,387</b> Conf. No: <b>7595</b>	
TITLE OF INVENTION: <b>FLIP-CHIP ON FILM ASSEMBLY FOR BALL...</b>	
TI FILE NO.: <b>TI-31794</b>	DEPOSIT ACCT. NO.: <b>20-0668</b>
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OCT 03 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
PATENT APPLICATION

Appl. No. : 09/992,387 Confirmation No. 7595  
Applicant : Anthony L. Coyle  
Filed : November 16, 2001  
TC/A.U. : 2822  
Examiner : Monica Lewis

Docket No. : TI-31794  
Customer No. : 23494

Commissioner for Patents  
P. O. Box 1450  
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10-3-2005  
Jackie McBride  
Jackie McBride

ELECTION

Sir:

In response to the Examiner's restriction requirement mailed September 9, 2005, applicants elect Group I, claims 25-31 without traverse.

Respectfully submitted,

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